## SF2220C

- Low Insertion Loss
- Excellent Size-to-performance Ratio
- Hermetic SM5050-8 Surface-mount Case
- Single-ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)



### 193.60 MHz SAW Filter

## Absolute Maximum Ratings

| Rating | Value | Units |
| :--- | :---: | :---: |
| Maximum Incident Power in Passband | +18 | dBm |
| Maximum DC Voltage on any Non-ground Terminal | 30 | VDC |
| Storage Temperature Range in Tape and Reel | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Suitable for Lead-free Soldering - Maximum Soldering Profile | $260^{\circ} \mathrm{C}$ for 30 s |  |



## Electrical Specifications

| Characteristic | Sym | Notes | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Nominal Center Frequency | $\mathrm{f}_{\mathrm{C}}$ | 1 | 193.60 |  |  | MHz |
| Passband: |  |  |  |  |  |  |
| Minimum Insertion Loss |  |  |  | 5.0 | 7.0 | dB |
| 3 dB Bandwidth | $\mathrm{BW}_{3}$ | 1, 2 | 110 | 145 |  | kHz |
| Amplitude Ripple, 193.56 to 193.64 MHz |  |  |  | 0.5 | 1.0 | $\mathrm{dB}_{\text {P-P }}$ |
| Group Delay Variation, 193.545 to 193.655 MHz | GDV |  |  | 2100 | 2500 | $n S_{\text {P-P }}$ |
| Absolute Delay at 193.6 MHz | AGD |  | 5100 | 5400 | 5700 | ns |
| Rejection: |  | 1,2,3 |  |  |  |  |
| 193.49 and 193.71 MHz |  |  | 10 | 15 |  | dB |
| 30 dB Low Side Rejection Frequency |  |  | TBD | 193.432 |  | MHz |
| 30 dB High Side Rejection Frequency |  |  |  | 193.753 | TBD |  |
| Ultimate Rejection, <192.2 MHz, >195.0 MHz |  |  | 45 | 50 |  | dB |
| Operating Temperature Range | $\mathrm{T}_{\text {A }}$ | 1 | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |


| Impedance Matching to $50 \Omega$ Single-ended Source and Load | External L-C |
| :--- | :---: |
| Case Style | SM5050-8, $5 \times 5 \mathrm{~mm}$ Nominal Footprint |
| Lid Symbolization $(\mathrm{YY}=$ year, WW $=$ week $)$ | $957, \mathrm{YYWW}$ |

## 4 <br> CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. <br> Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to $50 \Omega$ and measured with $50 \Omega$ network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. The turnover temperature, $T_{O}$, is the temperature of maximum (or turnover) frequency, $f_{0}$. The nominal frequency at any case temperature, $T_{C}$, may be calculated from: $f=f_{0}\left[1-F T C\left(T_{0}-T_{c}\right)^{2}\right]$.
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.

## Frequency Respose Plots




## SM5050-8 Surface-Mount 8-Terminal Ceramic Case 5.0 X 5.0 mm Nominal Footprint



Case Dimensions

| Dimension | mm |  |  | Inches |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Nom | Max | Min | Nom | Max |
| A | 4.80 | 5.00 | 5.20 | 0.189 | 0.197 | 0.205 |
| B | 4.80 | 5.00 | 5.20 | 0.189 | 0.197 | 0.205 |
| C | 1.30 | 1.50 | 1.70 | 0.050 | 0.060 | 0.067 |
| D | 1.98 | 2.08 | 2.18 | 0.078 | 0.082 | 0.086 |
| E | 1.07 | 1.17 | 1.27 | 0.042 | 0.046 | 0.050 |
| F | 0.50 | 0.64 | 0.70 | 0.020 | 0.025 | 0.028 |
| G | 2.39 | 2.54 | 2.69 | 0.094 | 0.100 | 0.106 |
| H |  | 1.27 |  |  | 0.050 |  |
| I |  | 0.76 |  |  | 0.030 |  |
| J |  | 1.55 |  |  | 0.061 |  |
| K |  | 2.79 |  |  | 0.110 |  |
| L |  | 0.76 |  |  | 0.030 |  |
| M |  | 2.36 |  |  | 0.093 |  |
| N |  | 1.55 |  |  | 0.061 |  |
| O |  | 2.79 |  |  | 0.110 |  |
| P |  | 2.79 |  |  | 0.110 |  |
| Q |  | 2.79 |  |  | 0.110 |  |

Case Materials

| Materials |  |
| :---: | :---: |
| Solder Pad <br> Plating | 0.3 to $1.0 \mu \mathrm{~m}$ Gold over 1.27 to $8.89 \mu \mathrm{~m}$ Nickel |
| Lid Plating | 2.0 to $3.0 \mu \mathrm{~m}$ Nickel |
| Body | $\mathrm{Al}_{2} \mathrm{O}_{3}$ Ceramic |
| Pb Free |  |

Electrical Connections

| Connection |  | Terminals |
| :--- | :--- | :---: |
| Port 1 | Input | 2 |
| Port 2 | Output | 6 |
|  | Ground | All others |
|  |  |  |



## Tape and Reel Specifications



COMPONENT ORIENTATION and DIMENSIONS

| Carrier Tape Dimensions |  |
| :---: | :---: |
| Ao | 5.3 mm |
| Bo | 5.3 mm |
| Ko | 2.0 mm |
| Pitch | 8.0 mm |
| W | 12.0 mm |



